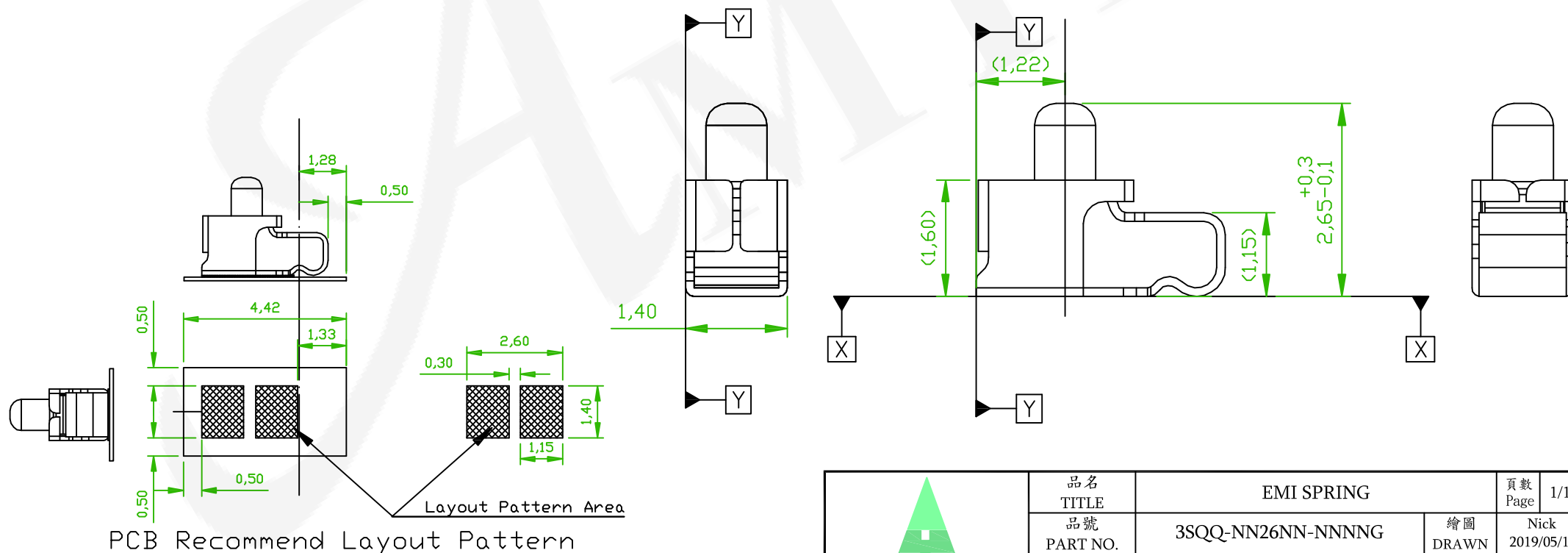
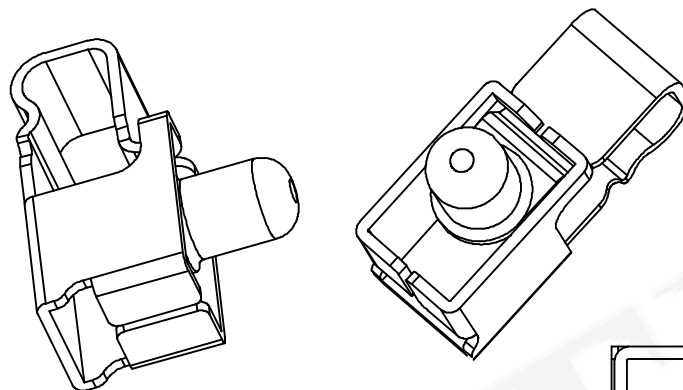


- 1.Material: BeCu
- 2.Thickness: 0.12mm
- 3.Electroplate:
 - Au >1u" on contact area
 - Gold Flash on Solder area
 - Nickel Underplating over All
- 4.Height of Application:
 - 1.65~2.25mm(Single actuation)
 - 1.70~2.25mm(Repeated atuation)



REV.	ECN NO. OR DESCRIPTION	REVISED	DATE



糧德精密有限公司
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品名 TITLE	EMI SPRING				頁數 Page	1/1
品號 PART NO.	3SQQ-NN26NN-NNNNG			繪圖 DRAWN	Nick 2019/05/13	
圖號 DRAWING NO.	GW271-NI143	版本 REV.	A	核對 CHECKED	Josh 2019/05/13	
客戶品號 CUSTOMER P/N		比例 SCALE	None	承認 APPROVED	Josh 2019/05/13	
公差 TOLERANCE	±0.20	單位 UNIT	mm	THIRD ANGLE PROJECTION		